

Product Summary (@ $T_A = +25^\circ\text{C}$)

V_{RRM} (V)	I_O MAX (A)	V_F MAX (V)	I_R MAX (μA)
400, 600, 800, 1000	3	1.1	5

Features and Benefits

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1000 PRV
- Low Reverse Leakage Current
- Surge Overload Rating to 90A Peak
- Ideal for Printed Circuit Board Applications
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**

Description and Applications

Suitable for AC to DC bridge full wave rectification for AC/DC Power Supply, LED lighting, home appliances, office equipment, and telecommunication applications.

Mechanical Data

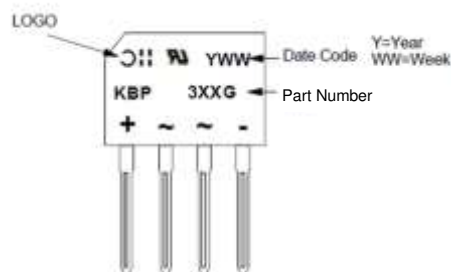
- Case: KBP
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Tin. Plated Leads, Solderable per MIL-STD-202, Method 208
- Polarity: Marked on Body
- Weight: 1.52 grams (Approximate)

KBP

Ordering Information (Note 3)

Part Number	Compliance	Case	Packaging
KBP304G	Commercial	KBP	35 Pieces per Tube
KBP306G	Commercial	KBP	35 Pieces per Tube
KBP308G	Commercial	KBP	35 Pieces per Tube
KBP310G	Commercial	KBP	35 Pieces per Tube

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information


Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	KBP304G	KBP306G	KBP308G	KBP310G	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	400	600	800	1000	V
Working Peak Reverse Voltage	V _{RWM}					
DC Blocking Voltage	V _{RM}					
RMS Reverse Voltage	V _{R(RMS)}	280	420	560	700	V
Average Rectified Output Current (With Heatsink)	I _O	3.0				A
@T _C = +105°C (Without Heatsink)		1.9				
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load @T _J = +125°C	I _{FSM}	90				A
@T _J = +25°C		80				
Non-Repetitive Peak Forward Surge Current 1.0ms Single Half Sine-Wave Superimposed on Rated Load @ T _J = +125°C	I _{FSM}	180				A
@ T _J = +25°C		160				
I ² t Rating for Fusing (3ms ≤ t ≤ 8.3ms)	I ² t	26.5				A ² s

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 4)	R _{θJC}	10	°C/W
Typical Thermal Resistance, Junction to Lead (Note 4)	R _{θJL}	12	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 4)	R _{θJA}	30	°C/W
Typical Thermal Resistance, Junction to Case (Note 5)	R _{θJC}	12	°C/W
Typical Thermal Resistance, Junction to Lead (Note 5)	R _{θJL}	18	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	40	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	1,000	KBP310G	—	—	V	I _R = 5μA
		800	KBP308G				
		600	KBP306G				
		400	KBP304G				
Forward Voltage Drop per Element	V _F	—	0.91	1.1	V	I _F = 3A, T _J = +25°C	
Leakage Current (Note 6)	I _R	—	—	5 500	μA	V _R = V _{RRM} , T _J = +25°C V _R = V _{RRM} , T _J = +125°C	
Total Capacitance per Element	C _T	—	35	—	pF	V _R = 4.0V _{DC} , f = 1MHz	

Notes: 4. Thermal resistance from junction to case per element. Device mounted on 30mm x 30mm x 1mm Cu Plate Heatsink.
5. Thermal resistance from junction to case per element without heat sink.
6. Short duration pulse test used to minimize self-heating effect.

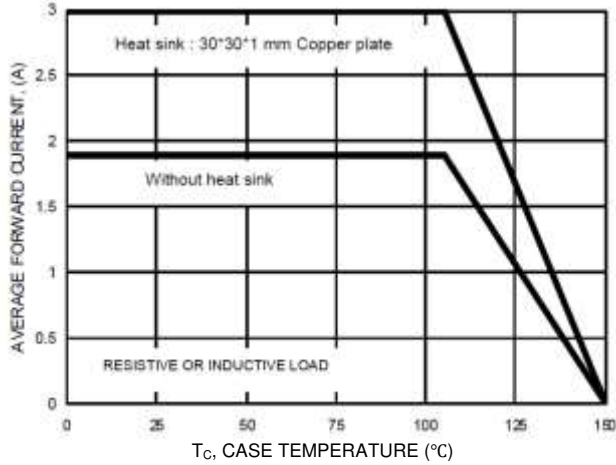


Figure 1. Forward Current Derating Curve

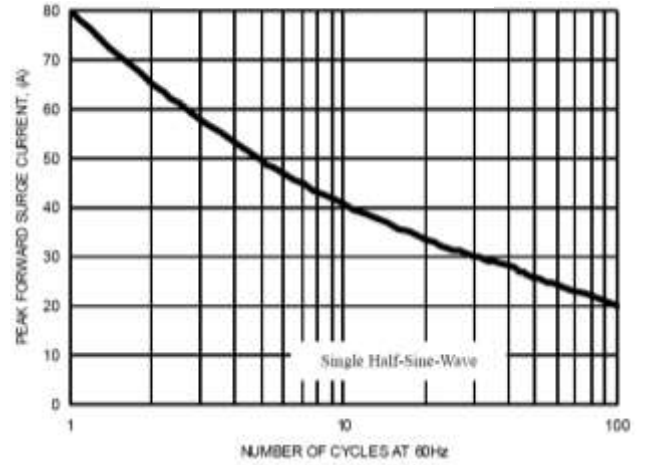


Figure 2. Maximum Non-repetitive Surge Current

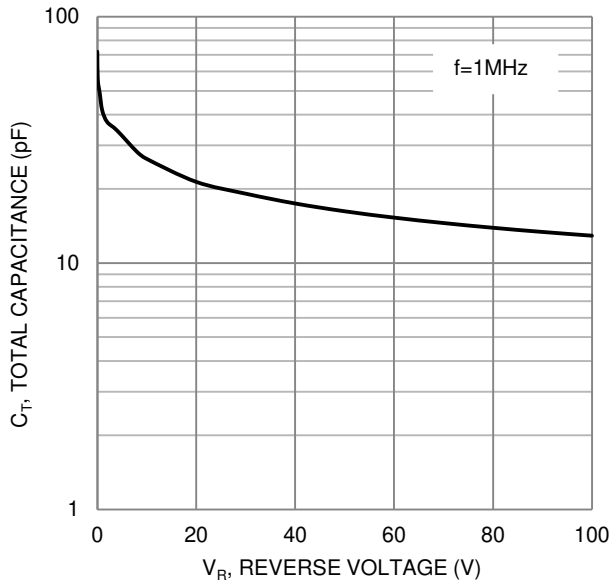


Figure 3. Typical Total Capacitance (Per Element)

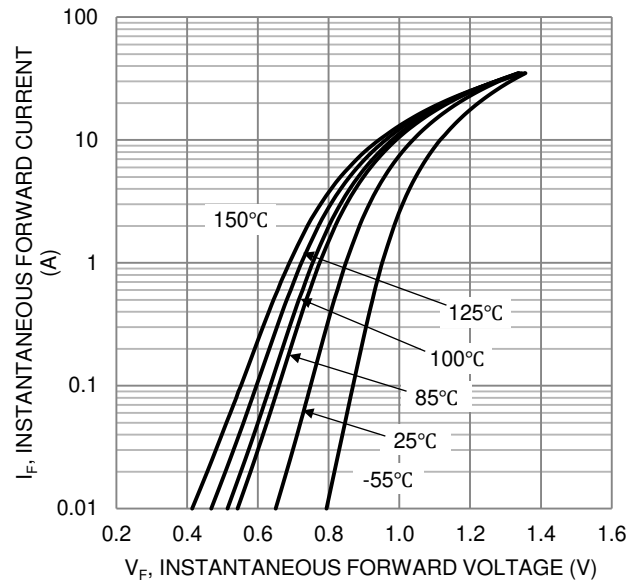


Figure 4. Typical Forward Characteristics

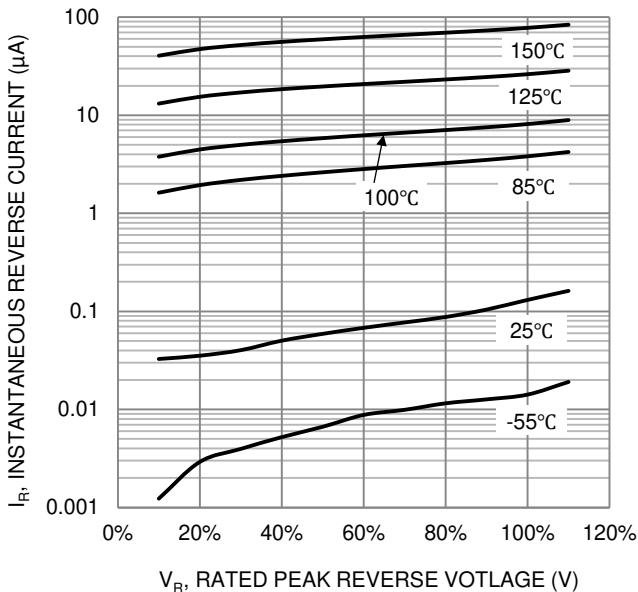


Figure 5. Typical Reverse Characteristics

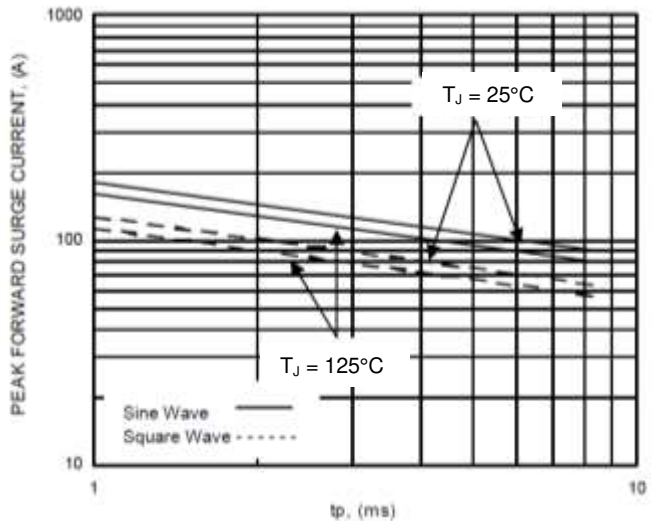
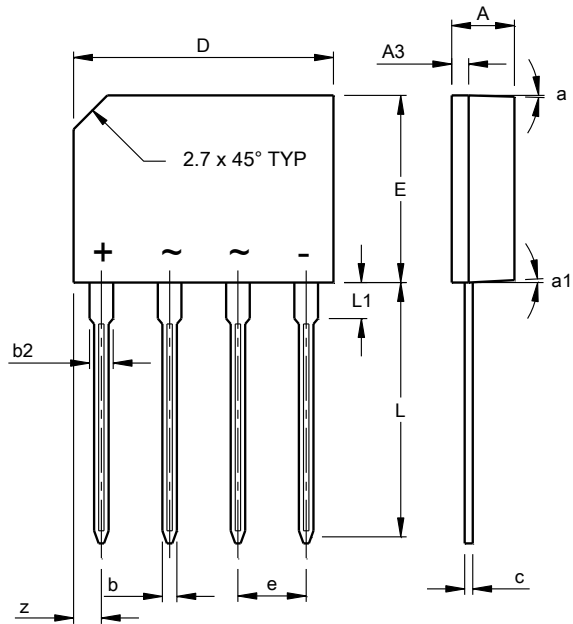


Figure 6. Non-repetitive Surge Current

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

KBP



KBP			
Dim	Min	Max	Typ
A	3.35	3.65	-
A3	0.80	1.10	-
b	0.76	0.86	-
b2	1.22	1.42	-
c	0.35	0.55	-
D	14.25	14.75	-
E	10.20	10.60	-
e	3.56	4.06	-
L	14.25	14.73	-
L1	1.80	2.20	-
z	1.40	1.70	-
a	-	-	3°
a1	-	-	2°
All Dimensions in mm			

NEW PRODUCT

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